

MOSFET

OptiMOS[™] 6 Power-Transistor, 100 V

Features

- N-channel, normal level
- Very low on-resistance R_{DS(on)}
- Excellent gate charge x R_{DS(on)} product (FOM)
 Very low reverse recovery charge (Q_{rr})
- · High avalanche energy rating
- 175°C operating temperature
- Optimized for high frequency switching and synchronous rectification
 Pb-free lead plating; RoHS compliant
 Halogen-free according to IEC61249-2-21

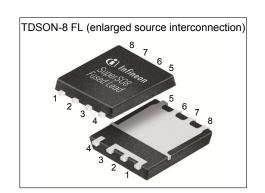
- MSL 1 classified according to J-STD-020

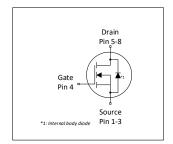


Fully qualified according to JEDEC for Industrial Applications

Key Performance Parameters Table 1

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Parameter	Value	Unit					
V _{DS}	100	V					
R _{DS(on),max}	3.0	mΩ					
I _D	179	A					
Qoss	101	nC					
Q _G (0V10V)	55	nC					
Q _{rr} (100A/μs)	56	nC					











Type / Ordering Code	Package	Marking	Related Links
ISC030N10NM6	PG-TDSON-8 FL	030N10N6	-

OptiMOS[™] 6 Power-Transistor, 100 V ISC030N10NM6



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OptiMOS[™] 6 Power-Transistor, 100 V ISC030N10NM6



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Davamatar	0		Value	S			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Continuous drain current ¹⁾	I _D	- - -	- - -	179 127 110 21	A	V_{GS} =10 V, T_{C} =25 °C V_{GS} =10 V, T_{C} =100 °C V_{GS} =8 V, T_{C} =100 °C V_{GS} =10V, T_{A} =25 °C, R_{thJA} =50 °C/W ²⁾	
Pulsed drain current ³⁾	I _{D,pulse}	-	-	716	Α	<i>T</i> _A =25 °C	
Avalanche current, single pulse ⁴⁾	I _{AS}	-	-	50	Α	T _C =25 °C	
Avalanche energy, single pulse	E AS	-	-	988	mJ	$I_{\rm D}$ =18 A, $R_{\rm GS}$ =25 Ω	
Gate source voltage	V _{GS}	-20	-	20	V	-	
Power dissipation	P _{tot}	-	-	208 3.0	W	T _C =25 °C T _A =25 °C, R _{thJA} =50 °C/W ²⁾	
Operating and storage temperature	$T_{\rm j},~T_{\rm stg}$	-55	-	175	°C	-	

2 Thermal characteristics

Table 3 Thermal characteristics

Downwotor	Cumbal	Values			l lmi4	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case, bottom	R _{thJC}	-	0.36	0.72	°C/W	-
Thermal resistance, junction - case, top	R _{thJC}	-	-	20	°C/W	-
Thermal resistance, junction - ambient, 6 cm² cooling area	R _{thJA}	-	-	50	°C/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

2) Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

4) See Diagram 13 for more detailed information

OptiMOS[™] 6 Power-Transistor, 100 V ISC030N10NM6



3 Electrical characteristics

at T_j=25 °C, unless otherwise specified

Table 4 Static characteristics

D	0		Value	S	11	N	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Drain-source breakdown voltage	V _{(BR)DSS}	100	-	-	V	V _{GS} =0 V, I _D =1 mA	
Gate threshold voltage	V _{GS(th)}	2.3	2.8	3.3	V	V _{DS} =V _{GS} , I _D =109 μA	
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1.0 100	μA	V _{DS} =80 V, V _{GS} =0 V, T _j =25 °C V _{DS} =80 V, V _{GS} =0 V, T _j =125 °C ¹⁾	
Gate-source leakage current	I_{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V	
Drain-source on-state resistance	R _{DS(on)}	-	2.6 3.1	3.0 4.0	mΩ	V _{GS} =10 V, I _D =50 A V _{GS} =8 V, I _D =25 A	
Gate resistance	R _G	0.52	1.05	1.56	Ω	-	
Transconductance	g fs	41	82	-	S	$ V_{DS} \ge 2 I_D R_{DS(on)max}, I_D = 50 A$	

Table 5 Dynamic characteristics

Danamatan	Cymahal	Values			I I m i 4	Nata / Tant Candition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance	Ciss	-	4000	5200	pF	V _{GS} =0 V, V _{DS} =50 V, f=1 MHz
Output capacitance ¹⁾	Coss	-	900	1100	pF	V _{GS} =0 V, V _{DS} =50 V, f=1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	15	22	pF	V _{GS} =0 V, V _{DS} =50 V, f=1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	11	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =25 A, $R_{\rm G,ext}$ =1.6 Ω
Rise time	t _r	-	4.5	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =25 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	$t_{ m d(off)}$	-	22.5	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =25 A, $R_{\rm G,ext}$ =1.6 Ω
Fall time	t _f	-	5.3	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =25 A, $R_{\rm G,ext}$ =1.6 Ω

Table 6 Gate charge characteristics²⁾

Davamatav	Oh. a.l.		Values			Nata / Tank Open Hitian
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge ¹⁾	Q _{gs}	-	18	24	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =25 A, $V_{\rm GS}$ =0 to 10 V
Gate charge at threshold ¹⁾	$Q_{g(th)}$	-	11	14	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =25 A, $V_{\rm GS}$ =0 to 10 V
Gate to drain charge ¹⁾	$Q_{ m gd}$	-	9.1	14	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =25 A, $V_{\rm GS}$ =0 to 10 V
Switching charge	Q _{sw}	-	16	-	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =25 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total ¹⁾	Qg	-	55	69	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =25 A, $V_{\rm GS}$ =0 to 10 V
Gate plateau voltage	V _{plateau}	-	4.6	-	V	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =25 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total, sync. FET	Q _{g(sync)}	-	50	-	nC	V _{DS} =0.1 V, V _{GS} =0 to 10 V
Output charge ¹⁾	Qoss	-	101	126	nC	V _{DS} =50 V, V _{GS} =0 V

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

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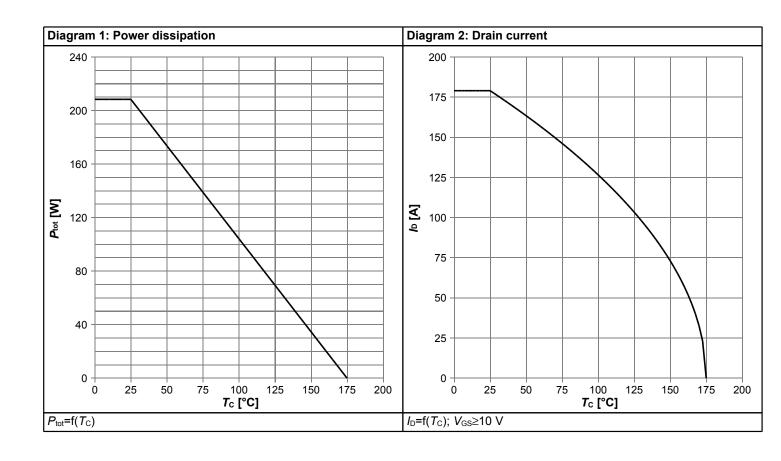


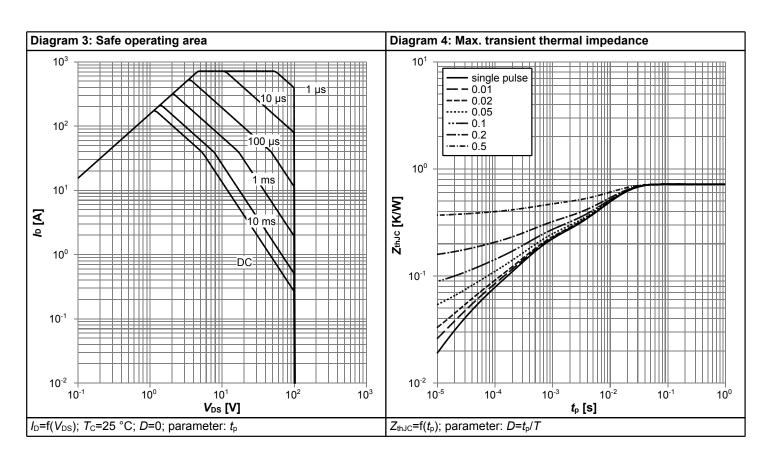
Table 7 Reverse diode

Development	Cymphol		Values			Nata / Tank Canadition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	Is	-	-	179	Α	<i>T</i> _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	716	Α	T _C =25 °C
Diode forward voltage	V _{SD}	-	0.82	1.0	V	V _{GS} =0 V, I _F =50 A, T _j =25 °C
Reverse recovery time ¹⁾	<i>t</i> _{rr}	-	46.5	70	ns	V _R =50 V, I _F =25 A, di _F /dt=100 A/μs
Reverse recovery charge ¹⁾	Qrr	-	56	84	nC	V _R =50 V, I _F =25 A, di _F /dt=100 A/μs
Reverse recovery time ¹⁾	<i>t</i> _{rr}	-	25.5	38	ns	V _R =50 V, I _F =25 A, di _F /dt=1000 A/μs
Reverse recovery charge ¹⁾	Qrr	-	266	399	nC	V _R =50 V, I _F =25 A, d <i>i</i> _F /d <i>t</i> =1000 A/μs

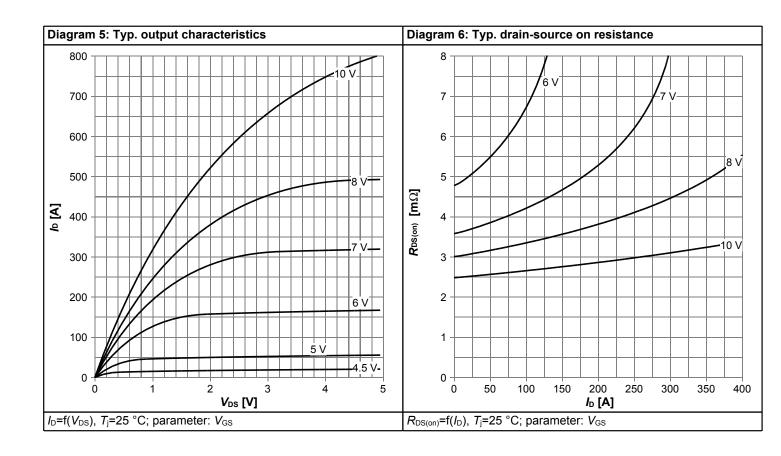


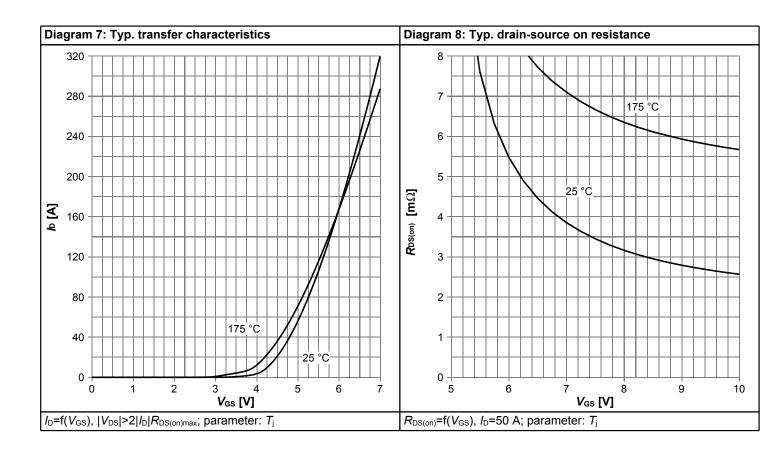
4 Electrical characteristics diagrams



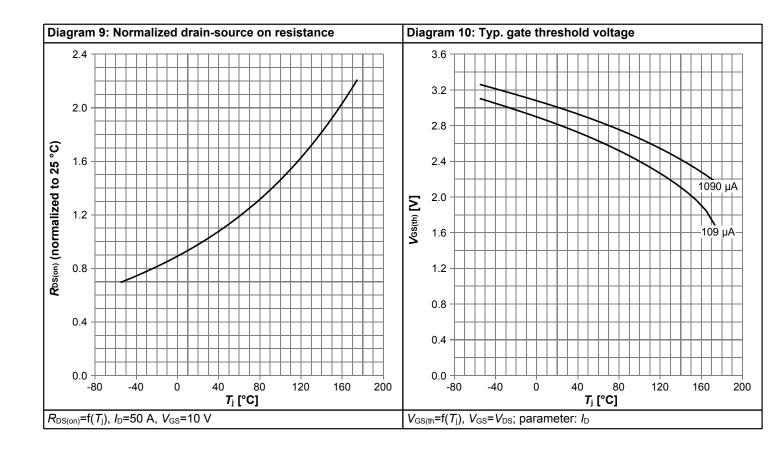


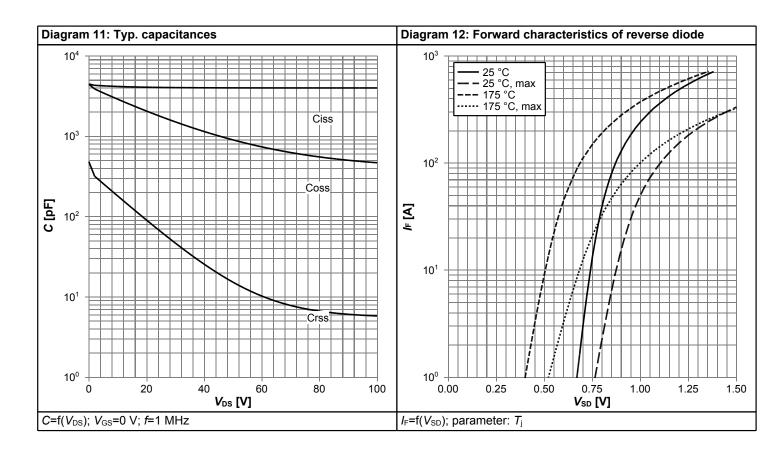




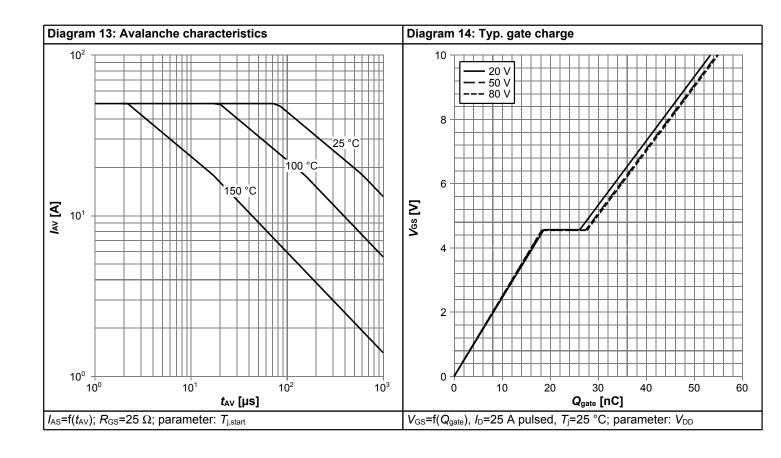


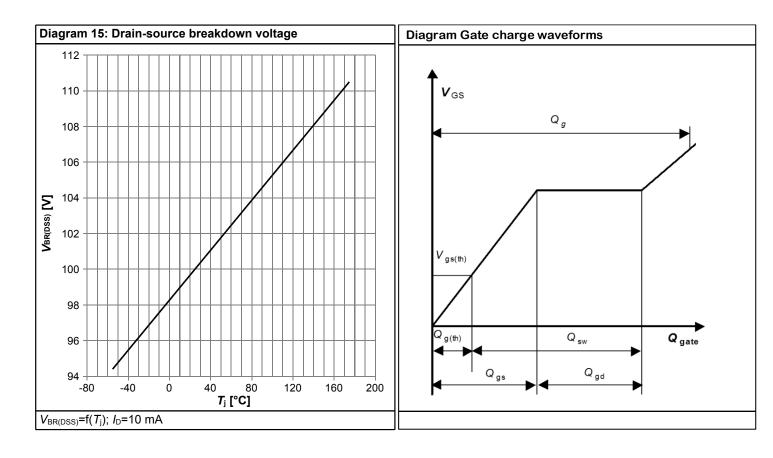






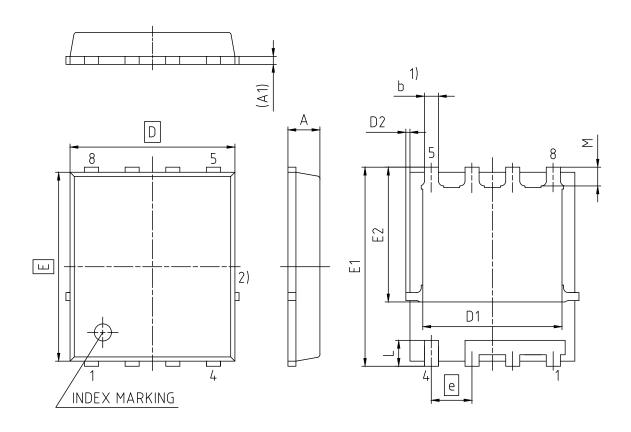








5 Package Outlines



1) EXCLUDING MOLD FLASH
2) REMOVAL ON MOLD GATE
INTRUSION 0.1 MM
PROTRUSION 0.1 MM
LEAD LENGTH UP TO ANTI FLASH LINE
ALL METAL SURFACES ARE PLATED, EXCEPT AREA OF CUT

DIMENSION	MILLIM	ETERS				
DIMENSION	MIN.	MAX.				
Α	0.90	1.20				
A1	0.15	0.35				
b	0.26	0.54				
D	4.80	5.35				
D1	3.70	4.40				
D2	0.00	0.23				
Е	5.70	6.10				
E1	5.90	6.42				
E2	3.88	4.42				
е	1.27					
L	0.69	0.90				
М	0.45	0.69				

DOCUMENT NO. Z8B000193699			
REVISION 04			
SCALE 10:1			
0 1 2 3mm			
EUROPEAN PROJECTION			
ISSUE DATE 05.11.2019			

Figure 1 Outline PG-TDSON-8 FL, dimensions in mm



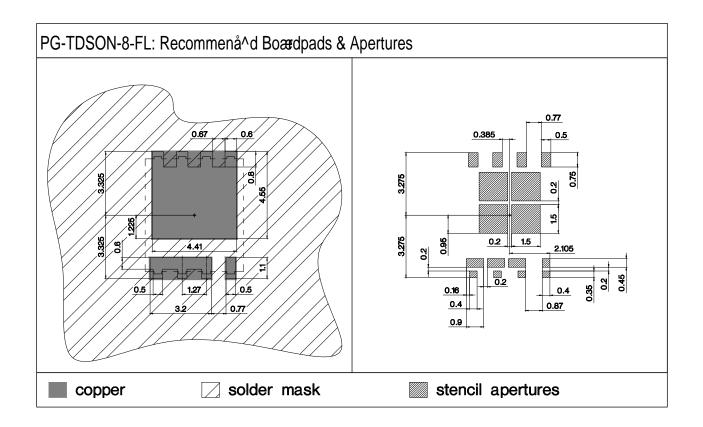


Figure 2 Outline Boardpads (TDSON-8 FL)

OptiMOS TM 6 Power-Transistor , 100 V ISC030N10NM6



Revision History

ISC030N10NM6

Revision: 2023-02-14, Rev. 2.2

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.0	2021-07-05	Release of final version
2.1	2021-07-20	Update Diagram 10
2.2	2023-02-14	Update SOA Diagram

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